

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
YU-CHING LIU	12/20/2010
CHI-AN YU	12/20/2010
XI-HANG LI	12/20/2010
BING LIU	12/20/2010
ZHI-BING LI	12/20/2010
JIE-PENG KANG	12/20/2010
JING-BIN LIANG	12/20/2010
HAI-GUI HUANG	12/20/2010

RECEIVING PARTY DATA

Name:	Fu Tai Hua Industry (Shenzhen) Co., Ltd.
Street Address:	Area B, Foxconn Guanlan Technology Park, Dasan Community, Guanlan Sub-District
City:	ShenZhen City, Guangdong Province
State/Country:	CHINA

Name:	HON HAI PRECISION INDUSTRY CO., LTD.
Street Address:	66, CHUNG SHAN ROAD
City:	Tu-Cheng, Taipei Hsien
State/Country:	TAIWAN

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12982813

CORRESPONDENCE DATA

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**PATENT
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ATTORNEY DOCKET NUMBER:	US34440
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NAME OF SUBMITTER:	Raymond J. Chew
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Total Attachments: 2 source=US34440101228ASM#page1.tif source=US34440101228ASM#page2.tif
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ASSIGNMENT

In consideration of value received, the receipt and sufficiency of which are hereby acknowledged, the undersigned ASSIGNOR(S)

- 1. YU-CHING LIU , residing at Tu-Cheng, Taipei, Taiwan
- 2. CHI-AN YU , residing at Tu-Cheng, Taipei, Taiwan
- 3. XI-HANG LI , residing at Shenzhen, Guangdong, China
- 4. BING LIU , residing at Shenzhen, Guangdong, China
- 5. ZHI-BING LI , residing at Shenzhen, Guangdong, China
- 6. JIE-PENG KANG , residing at Shenzhen, Guangdong, China
- 7. JING-BIN LIANG , residing at Shenzhen, Guangdong, China
- 8. HAI-GUI HUANG , residing at Shenzhen, Guangdong, China

hereby sell(s), assign(s) and transfer(s) unto: **FU TAI HUA INDUSTRY (SHENZHEN) CO., LTD.** having a principal place of business at **Area B, Foxconn Guanlan Technology Park, Dasan Community, Guanlan Sub-District, Bao'an District, Shenzhen City, Guangdong Province, P.R.C.** and **HON HAI PRECISION INDUSTRY CO., LTD.** having a principal place of business at **66, Chung Shan Road, Tu-Cheng City, Taipei Hsien, Taiwan, R.O.C.** hereafter designated "ASSIGNEE" the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100, in the invention and all patent applications including any and all divisions, continuations, substitutes, and reissues thereof, and all resulting patents, known as **REPAIR APPARATUS AND METHOD FOR CIRCUIT BOARD ASSEMBLY** for which the undersigned

[] previously executed --- Ser. No. _____ and filing date of _____
 [x] is executing concurrently herewith

an application for Letters Patent of United States of America

AND the undersigned hereby authorize(s) and request(s) the United States Commissioner of Patents and Trademarks to issue said Letters Patent to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree(s) that the attorneys of record in said application, if any, shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree(s) to testify and execute any papers for ASSIGNEE, its successors, assigns and legal representatives, deemed essential by ASSIGNEE to ASSIGNEE's full protection and title in and to the invention hereby transferred.

